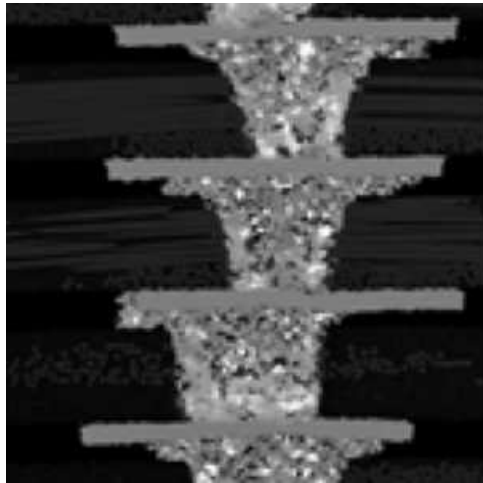


Ormet is a Conductive paste

"Sintering, Electrically Conductive Interconnect Materials"

Ormet is a sintering, electrically conductive materials for use in the manufacture of advanced electronic devices. Located in San Diego, California, the Company has distribution and representative organizations throughout the world.



"Every Layer Interconnect Technology Using Transient Liquid Phase Sintering Materials"

Market requirements for hand held mobile and pocketsize devices are driving circuit board technology to stacked microvia interconnect technology. Ormet supplies sintering interconnect materials with process knowledge and Intellectual Property Rights in TLPS technology designed to enable high performance PCB designs. Fabricators using Ormet's technology are capable of manufacturing micro-via products and high-layer count boards which offer the best signal integrity for high speed transmission.

Ormet's commercial success in enabling high performance PCBs with TLPS technology is now providing opportunities in the low cost mobile devices market. Learn more by viewing the linked presentation about the drivers for TLPS materials and its market adoption. Samples can be provided by contacting your local sales agent or through this link.